Unit; mm)

5.4

GP2S28

■ Features

- 1. Long focal distance type (Detecting range: 6mm)
- 2. With pins for protection of wrong insertion
- 3. Snap-in mounting type

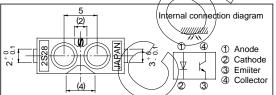
■ Applications

- 1. CD players
- 2. Facsimiles
- 3. Printers

Long Focal Distance, Case Type Photointerrupter

■ Outline Dimensions

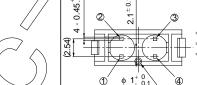
12.8 + 0.2



Surface of sensor



4 - 0.45 + 0.15



- * Unspecified tolerance :± 0.2mm *(): Reference dimensions
- * Thin burr is not included in tolerance.

■ Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

	Parameter	Symbol	Rating	Unit
Input	Forward current	I_{F}	60	mA
	*1Peak forward current	I_{FM}	1	A
	Reverse voltage	V_R	6	V
	Power dissipation	P	150	mW
Output	Collector-emitter voltage	V _{CEO}	V _{CEO} 35	
	Emitter-collector voltage	V_{ECO}	6	V
	Collector current	I_{C}	20	mA
	Collector power dissipation	Pc	50	mW
	Operating temperature	T opr	- 25 to + 85	°C
^	Storage temperature	T stg	- 40 to + 85	°C
	*2Soldering temperature	T sol	260	°C

^{*1} Pulse width = 100 \mu s, Duty ratio: 0.01

^{*2} For 5 seconds

75 85 100

Ambient temperature T a (°C)

■ Electro-optical Characteristics

	<u> </u>						1 (
Parameter		Symbol	Condition	MIN.	TYP.	MAX.	Unit	
Input	Forward voltage		$V_{\rm F}$	$I_F = 20 \text{mA}$	-	1.3	1(5	V
	Peak forward voltag	ge	V_{FM}	$I_F = 0.5A$	-	2.2	3.5	V
	Reverse current		I_R	$V_R = 3V$	-		10	μА
Output	Collector current		I _{CEO}	$V_{CE} = 20V$	-	(1(100	nA
Transfer characteristics	Collector current		Ic	$V_{CE} = 5V, I_F = 20mA, *3$	0.04	1-/	0,9/	mA
	Collector-emitter saturat	ion voltage	V _{CE(sat)}	$I_F = 40mA, I_C = 0.04mA$	- /-	5-	0.4	V
	Response time	Rise time	t _r	$V_{CE} = 2V$, $I_C = 0.1mA$	1	-	20	μs
		Fall time	$t_{\rm f}$	$R_L = 100 \Omega$	- (-)	30	μs

^{*3} The condition and arrangement of reflective object is shown in the following figure.

Test Circuit for Response Time Test Arrangement of Collector Current Reflective object Anode ○ O Vcc Reflective object Kodak 90 % Input reflective paper R_L Collector d = 7mm10% Output 90% Fig. 1 Forward Current vs. Fig. 2 Collector Power Dissipation vs. **Ambient Temperature Ambient Temperature** 70 60 Collector power dissipation P_C (mW) 60 50 Forward current I_F (mA) 50 40 40 30 30 20 20 10

- 25

75 85 100

Ambient temperature T_a (°C)

Fig. 3 Peak Forward Current vs. Duty Ratio

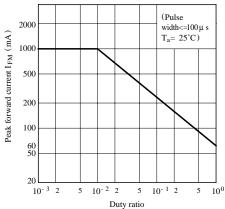


Fig. 5 Collector-current vs. Forward Currnt

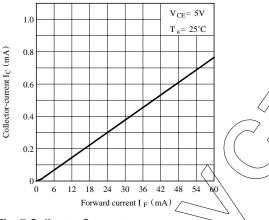


Fig. 7 Collector Current vs.

Ambient Temperature

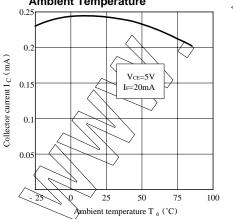


Fig. 4 Forward Current vs.

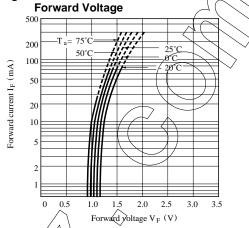


Fig. 6 Collector Current vs.
Collector-emitter Voltage

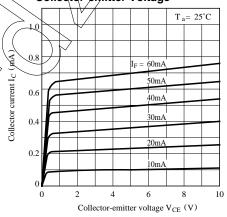


Fig. 8 Collector Dark Current vs.
Ambient Temperature

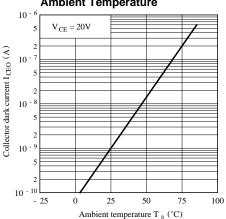
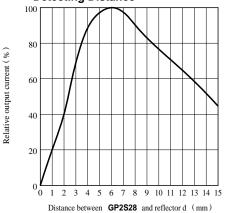
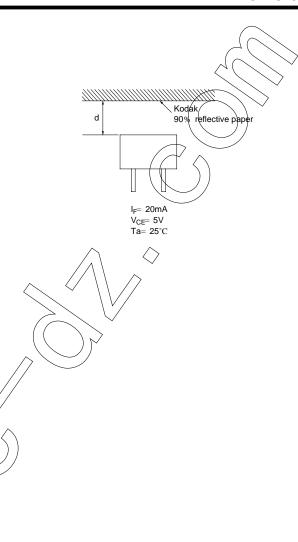
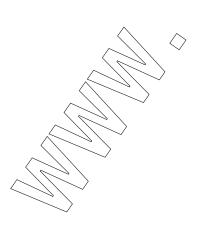


Fig. 9 Relative Output Current vs. Detecting Distance



• Please refer to the chapter "Precautions for Use".





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